

# **LI-IMX219-MIPI-FF-NANO SPECIFICATION**

Model:

LI-IMX219-MIPI-FF-NANO-H90  
LI-IMX219-MIPI-FF-NANO-H136  
LI-IMX219-MIPI-FF-NANO-H145

**Rev 1.4**  
**Leopard Imaging Inc.**

## **Contents**

<b>Version History</b> .....	3
<b>Key Information</b> .....	4
<b>Pin Assignment</b> .....	5
<b>Electrical Characteristics</b> .....	6
<b>1. Absolute Maximum Ratings</b> .....	6
<b>2. Recommended Operating Conditions</b> .....	6
<b>3. Spectral Sensitivity Characteristics</b> .....	6
<b>4. DC Characteristics</b> .....	7
<b>5. Electrical Characteristics</b> .....	7
<b>6. AC Characteristics</b> .....	8
<b>7. Power On Sequence</b> .....	9
<b>8. Power Off Sequence</b> .....	10
<b>Mechanical Drawing</b> .....	11



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

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## Version History

Version	Description	Release Date
1.0	First Release	16. Mar. 2019
1.1	Add H90 and H135 version	22. Mar. 2019
1.2	Update the dimensions of H90 and H135 modules	14. Apr. 2019
1.3	Remove H135 module	26. Apr. 2019
1.4	Add H136 module	18. Oct. 2019



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## Key Information

Module Part#		LI-IMX219-MIPI-FF-NANO
Compatible Platform		NVIDIA® Jetson Nano™ Developer Kit
Module Size	H90	150.0 mm (L) x 25.0 mm (W) x 15.27 mm(H)
	H136	150.0 mm (L) x 25.0 mm (W) x 15.3 mm(H)
	H145	150.0 mm (L) x 25.0 mm (W) x 14.1 mm(H)
Sensor Type		Sony IMX219 8.08MP Color sensor
Active Pixels		3280 (H) x 2464 (V)
Image Size		Diagonal 4.60 mm (Type 1/4.0)
F/No		2.6 (H90) / 2.0 (H136) / 2.5 (H145)
Focal Length		2.3mm (H90) / 1.58mm (H136) / 1.55 mm (H145)
FOV		90 °(H) / 136 °(H) /145 °(H)
TV Distortion		< -10% (H90) / < -15%(H136) / < -15% (H145)
Focusing Range		30cm - Infinity
Pixel size		1.12 um x 1.12 um
IR Cutter Filter		Yes
Temperature Range	Operating	-20 °C to +60 °C
	Storage	-30 °C to +80 °C
Data Output Interface		CSI-2 MIPI 2-lane
Maximum Image Transfer Rate		3280 x 2464 @ 21fps
Mating	Part#	1-1734248-5
Connector	Number of Positions	15
	Pitch	0.039" (1.00mm)



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## Pin Assignment

No.	Name	Pin type	Description
1	GND	Ground	
2	MDN0	O	MIPI data positive output
3	MDP0	O	MIPI data negative output
4	GND	Ground	
5	MDN1	O	MIPI data positive output
6	MDP1	O	MIPI data negative output
7	GND	Ground	
8	MCN	O	MIPI clock negative output
9	MCP	O	MIPI clock positive output
10	GND	Ground	
11	RESET	I	Reset
12	FSTROBE	O	Strobe output
13	SCL	I	
14	SDA	I/O	
15	VCC3.3V	Power	



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## Sensor Specifications

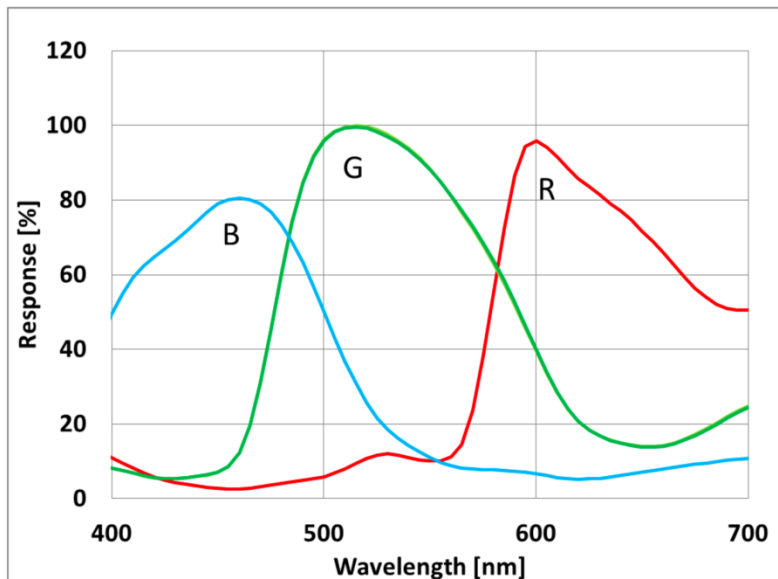
### 1. Absolute Maximum Ratings

Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
Supply voltage (analogue)	V <sub>ANA</sub>	-0.3		3.3	V	
Supply voltage (Core)	V <sub>DDL</sub>	-0.3		2.0	V	
Supply voltage (IF)	V <sub>DIG</sub>	-0.3		3.3	V	
Input voltage	V <sub>I</sub>	-0.3		3.3	V	
Output voltage	V <sub>O</sub>	-0.3		3.3	V	
Operating temperature (function)	T <sub>opr</sub>	-20		60	°C	Junction temperature
Storage temperature	T <sub>stg</sub>	-30		80	°C	Junction temperature
Performance guarantee temperature	T <sub>spec</sub>	-20		60	°C	Junction temperature

### 2. Recommended Operating Conditions

Item	Symbol	Min.	Typ.	Max.	Unit	Remarks
Supply voltage (analogue)	V <sub>ANA</sub>	2.6	2.8	3.0	V	
Supply voltage (Core)	V <sub>DDL</sub>	1.08	1.2	1.3	V	
Supply voltage (IF)	V <sub>DIG</sub>	1.62	1.8	1.98	V	

### 3. Spectral Sensitivity Characteristics



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## 4. DC Characteristics

Item	Pins	Symbol	Min.	Typ.	Max.	Unit	Comment
Supply voltage	VDDHFIL1,2	$V_{ANA}$	2.6	2.8	3.0	V	
	VDDHCM1,2						
	VDDHAN						
	VDDHPL						
	VDDHSN1,2						
	VDDMCO	$V_{DIG}$	1.62	1.8	1.98	V	
	VDDLSC1-8	$V_{DDL}$	1.08	1.20	1.30	V	
	VDDL CN1,2						
	VDDLIO1,2						
Digital input/output voltage	SCL, SDA, GPO	VIL	-0.5		$0.3V_{DIG}$	V	
		VIH	$0.7V_{DIG}$		$V_{DIG} + 0.5$	V	
		VOL			$0.25V_{DIG}$	V	
		VOH	$0.75V_{DIG}$			V	
Digital output voltage	FSTROBE	VOL			0.45	V	
		VOH	$V_{DIG} - 0.45$				
Digital input voltage	XCLR, INCK	VIL	-0.3		$0.35V_{DIG}$	V	
		VIH	$0.65V_{DIG}$		$V_{DIG} + 0.3$		

## 5. Electrical Characteristics

( $V_{ANA} = 3.0\text{ V}$ ,  $V_{DDL} = 1.3\text{ V}$ ,  $V_{DIG} = 1.98\text{ V}$ ,  $T_j = 60\text{ }^\circ\text{C}$ )

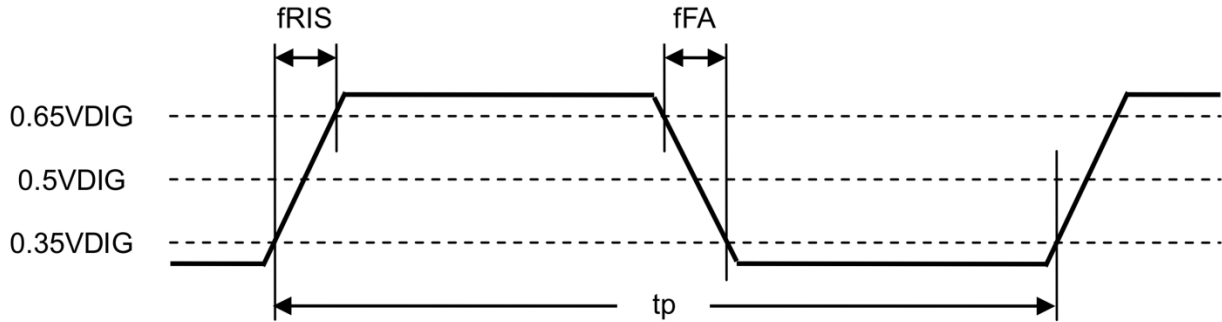
Item	Symbol	Min.	Typ.	Max.	Unit	Comment
Current consumption (Full, 30 frame/s)	IVAVA_strm		33	38	mA	VTmax is max speed read out from pixel array CSI2 4 lanes, $V_{ANA}$ current
	IVDDL_strm		100	160	mA	VTmax is max speed read out from pixel array CSI2 4 lanes, $V_{DDL}$ current Defect Correction, L.S.C. function off
HW-Standby current	ISTB_ana			50	$\mu\text{A}$	XCLR = Lo, $V_{ANA}$ current
	ISTB_dig			10	$\mu\text{A}$	XCLR = Lo, $V_{DIG}$ current
	ISTB_ddd			50	$\mu\text{A}$	XCLR = Lo, $V_{DDL}$ current



# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## 6. AC Characteristics

Input specifications are shown below when square-wave inputs directly into the external pin INCK.



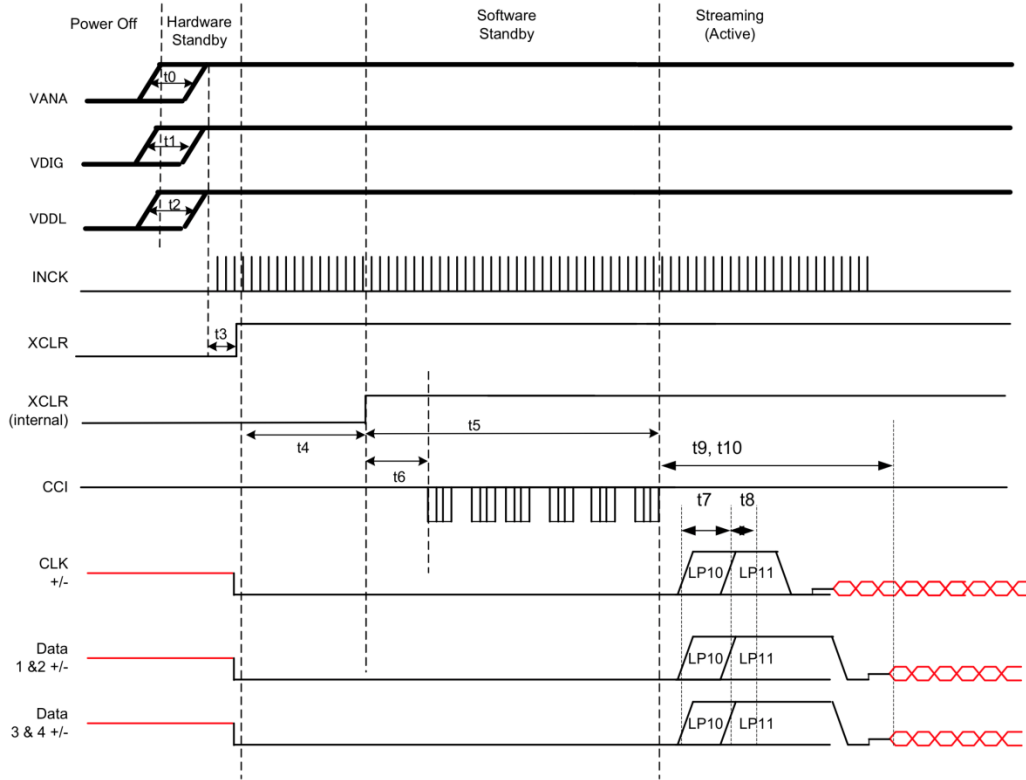
### Master Clock Square Waveform Input Characteristics

Item	Symbol	Min.	Typ.	Max.	Unit	Comment
Frequency	fSCK	6	18	27	MHz	
jitter (period, peak-to-peak)	Tjitter			600	ps	
Rise Time	fRISE	1		10	ns	
Fall Time	fFALL	1		10	ns	
Duty Cycle	fDUTY	40		60	%	
Input Leakage	fILEAK	-10		10	$\mu A$	



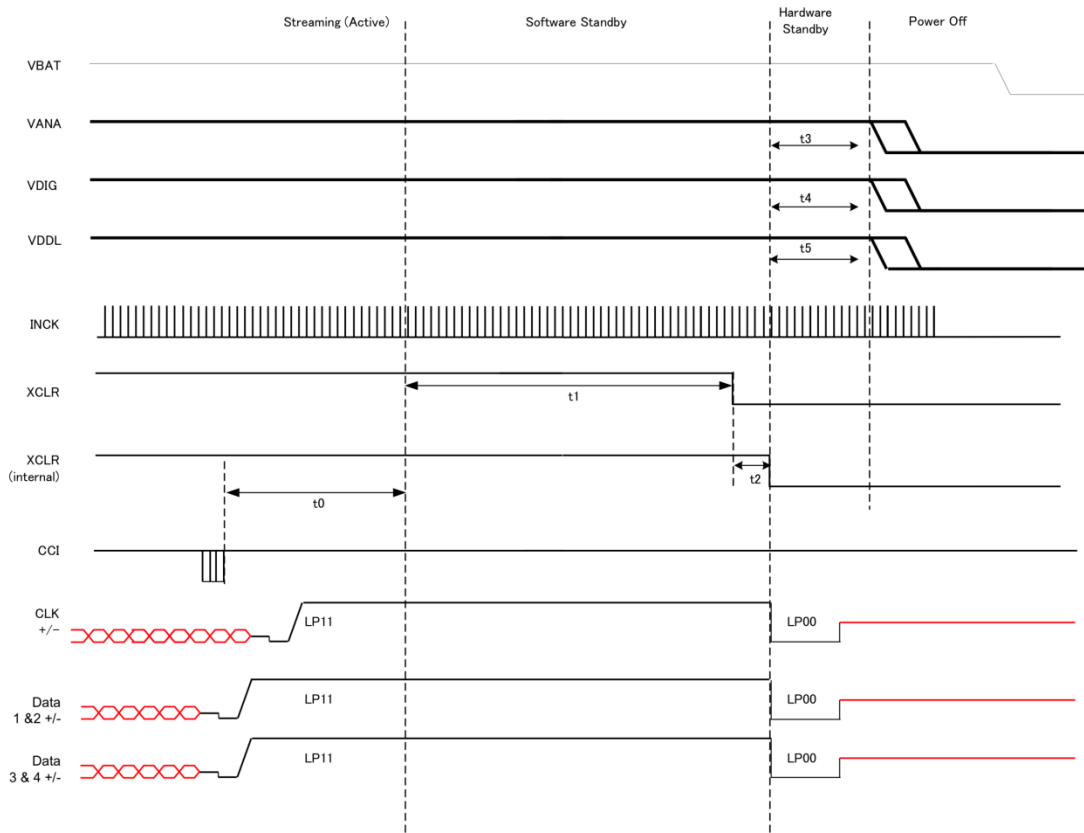
# LI-IMX219-MIPI-FF-NANO SPECIFICATION

## 7. Power On Sequence



Constraint	Label	Min.	Max.	Units	Comment
Sequence free of VDDs rising	$t_0, t_1, t_2$	VANA, VDIG, VDDL may rise in any order.		ns	
XCLR rising	$t_3$	0.5	—	$\mu$ s	
Internal XCLR is Low to High after VDDs & XCLR supplied	$t_4$		200	$\mu$ s	
releasing software standby after XCLR Low to High	$t_5$	6	—	ms	charge up VRL
Initializing time of silicon	$t_6$	—	32000	clocks	clock is INCK Case of INCK = 6[MHz], 5.3[msec]
D-PHY power-up	$t_7$	1	1.1	ms	
D-PHY init	$t_8$	100	110	$\mu$ s	
After releasing software standby to data streaming time	$t_9$	1.2 ms + exposure time	—		
Quick launch up time	$t_{10}$	—	1	frame	stable time until optimal image quality

## 8. Power Off Sequence



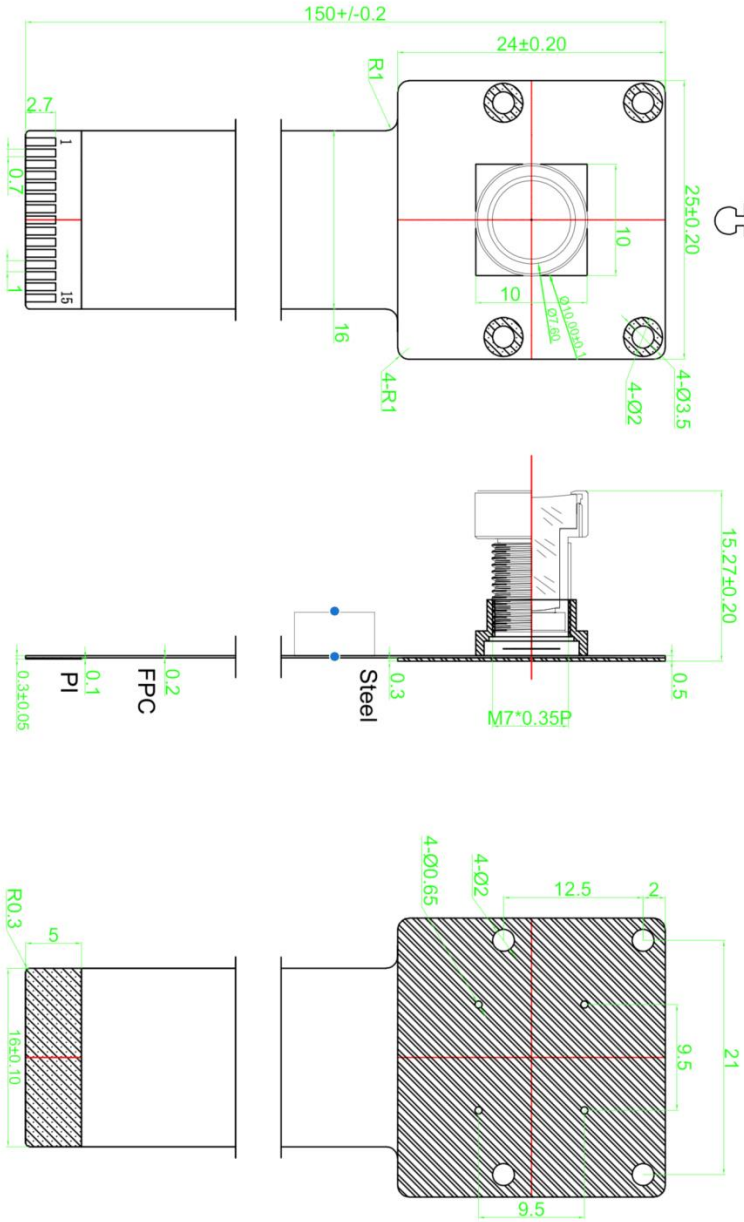
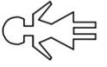
Constraint	Label	Min.	Max.	Units	Comment
Communication end – Software standby	t0		One frame time (*1)	s	Until frame output
Software standby - XCLR H → L	t1	0		ns	
Falling time of internal XCLR after XCLR H → L	t2		10	μs	
VANA falling - VDIG falling - VDDL falling	t3,t4,t5		VANA, VDIG and VDDL may fall in any order.	ns	

# LI-IMX219-MIPI-FF-NANO SPECIFICATION

ROHS

## LI-IMX219-MIPI-FF-NANO-H90

QR-RD-F002 Rev-A



**TOP VIEW**  
Note: # Image direction register use default settings.  
Output format: RGB output

**SIDE VIEW**

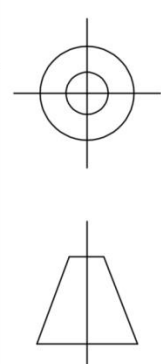
**BOTTOM VIEW**

NO.	SYMBOL
1	GND
2	MDN0
3	MDP0
4	GND
5	MDN1
6	MDP1
7	GND
8	MCN
9	MCP
10	GND
11	RESET
12	FSTROBE
13	SCL
14	SDA
15	VCC3.3V

Optical Lens Specification:  
Focusing Range 30cm to Infinity  
Focal Length 2.3mm  
F Number 2.6  
Fov(H) 90°  
TV Distortion <-10%

NO.	ITEM	QTY	DESCRIPTION
1	Steel	1	
2	FPC	1	
3	TAKING LENS	1	
4	Sensor	1	IMX219
5		1	
6	Test connector	1	1-1734248-5

补强: 10F1 版本: 1.2  
比例: 1:1 单位: MM



NO	变更资料	版本	时间	制作:	时间:	项目名称:
	Original	V1.0	2019-02-28	Brown	2019-03-20	LI-IMX219-MIPI-FF-NANO-H90 V1.2
	Change the FPC from 2 layers to 4layers	V1.1	2019-03-09	Brown	2019-03-20	
	Change Lens and Holder	V1.2	2019-03-21	Andy	2019-03-20	



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# LI-IMX219-MIPI-FF-NANO SPECIFICATION

ROHS

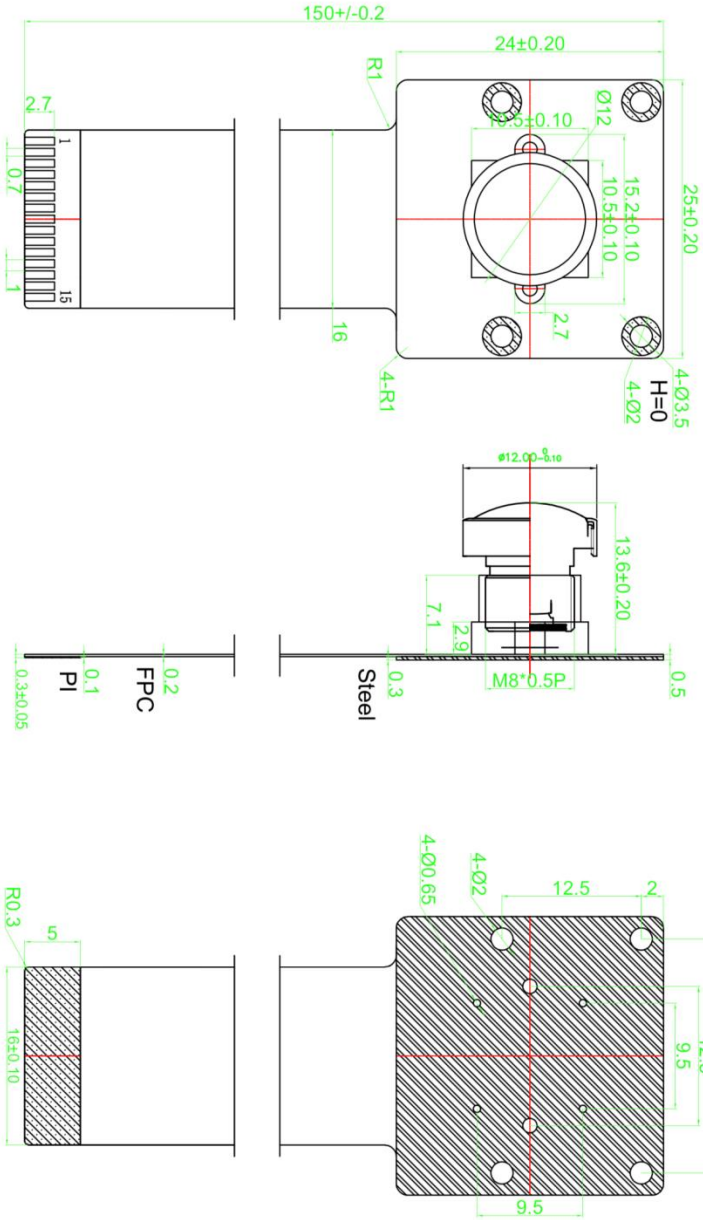
## LI-IMX219-MIPI-FF-NANO-H145

QR-RD-F002 Rev-A



advert:  
basic tolerance: ±0.1mm  
label have "\*"is emphasis dimension

Optical Lens Specification:  
Focusing Range 30cm to Infinity  
Focal Length 1.55mm  
F Number 2.5  
Fov(H) 145°  
TV Distortion <-1.5%



**TOP VIEW**

Note: # Image direction register use default settings.  
Output format: RGB output FPC 4 Layers

**SIDE VIEW**

**BOTTOM VIEW**

NO.	SYMBOL
1	GND
2	MDN0
3	MDP0
4	GND
5	MDN1
6	MDP1
7	GND
8	MCN
9	MCP
10	GND
11	RESET
12	FSTROBE
13	SCL
14	SDA
15	VCC3.3V

NO.	ITEM	QTY	DESCRIPTION
1	Steel	1	
2	FPC	1	
3	TAKING LENS	1	
4	Sensor	1	IMX219
5		1	
6	Test connector	1	1-1734248-5

补强: 10F1 版本: 1.1  
比例: 1:1 单位: MM

NO	变更资料	版本	时间	制作:	时间:	项目名称:
	Original	V1.0	2019-02-28	Brown	2019-03-20	Leopard Imaging Inc. LI-IMX219-MIPI-FF-NANO-H145 V1.2
	Change the FPC from 2 layers to 4layers	V1.1	2019-03-09	Brown	2019-03-20	
	Change FOV and TTL	V1.2	2019-03-18	Brown	2019-03-20	
				批准: Andy		

